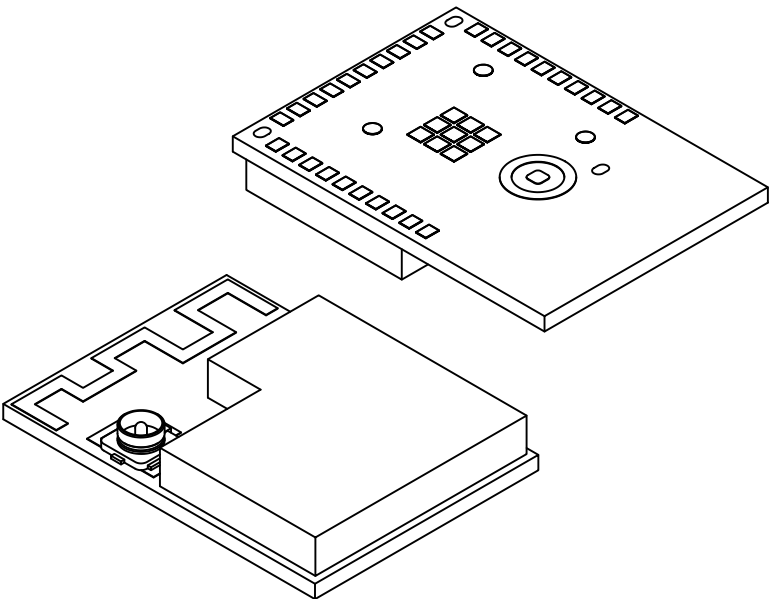


30-Lead Wireless Module (3BW) - 13.4x18.7X2.8 mm Body [Module]
With Metal Shield and Coaxial Connector

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	30		
Terminal Pitch	e	1.00 BSC		
Overall Height	A	2.60	2.80	3.00
PCB Thickness	A2	0.70	0.80	0.90
Shield Height	A3	1.90	2.00	2.10
UFL Connector Height	A4	1.25 REF		
Overall Length	D	13.30	13.40	13.50
Overall Width	E	18.60	18.70	18.80
Shield Length	D1	12.14	12.24	12.34
Shield Length	D2	6.60	6.70	6.80
Shield Width	E1	12.14	12.24	12.34
Shield Width	E2	8.92	9.02	9.12
Terminal Width	b	0.50	0.60	0.70
Terminal Length	L	0.70	0.80	0.90

Notes:

- 1. All Dimensions are in Millimeters
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.